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(71) Applicant:
**International Business Machines
Corporation
Armonk, N.Y. 10504 (US)**

(72) Inventor: **Vendramin, Giuseppe
24043 Caravaggio (BG) (IT)**

(74) Representative:
**Zerbi, Guido Maria
Intellectual Property Department,
IBM United Kingdom Ltd.,
Hursley Park
Winchester, Hampshire SO21 2JN (GB)**

(54) **Ball grid array module**

(57) A Plastic Ball Grid Array electronic package of the Cavity Down type for use in HF application. A Faraday Cage is realized to protect the active element from external HF wave interferences. The lateral sides of the Faraday Cage are constituted by a row of solder balls connected in a zig-zag way to plated through holes along the four edges of the substrate. The top side of the Cage is the metal stiffener of the Cavity Down package electrically connected to the through holes, while the bottom side is represented by the ground plane of the main board properly connected to the solder balls.

0 872 888 A3



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EUROPEAN SEARCH REPORT

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			H01L
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 18 March 1999	Examiner Prohaska, G
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

**ANNEX TO THE EUROPEAN SEARCH REPORT
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EP 97 30 8907

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